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FEB 2 6 2002 W

2/12/02

By:____

Drul Es

Rena Iov

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Chad A. Cobbley

APPLICATION NO.: 09/649,428

FILED: August 28, 2000

FOR: PACKAGED MICROELECTRONIC

DEVICES WITH

INTERCONNECTING UNITS AND METHODS FOR MANUFACTURING

AND USING THE

INTERCONNECTING UNITS

EXAMINER:

OLIK GHAUDHURI

ART UNIT:

2812

CONFIRMATION No.: 7172

<u>Information Disclosure Statement Within Three Months of</u>
<u>Application Filing or Before First Action - 37 CFR 1.97(b)</u>

Commissioner for Patents Washington, D.C. 20231

Sir:

1. <u>Timing of Submission</u>

This information disclosure is being filed within three months of the filing date of this application or date of entry into the national stage of an international application or before the mailing date of a first Office action on the merits, whichever occurs last [37 CFR 1.97(b)]. The references listed on the enclosed Form PTO/SB/08A may be material to the examination of this application; the Examiner is requested to make them of record in the application.

2. <u>Cited Information</u>

\boxtimes	Copies of the following reference	es are	enclosed:
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☐ References marked by asterisks

☐ The following:

	Copies of the following references can be found in parent application Ser.			
		All cited references References marked by asterisks The following:		
	by a the counter the notherw relevant	The following references are not in English. For each such reference, the indersigned has enclosed an English-language abstract for the reference prepared by a third party. Applicant has not verified that the translation, English-language counterpart or third-party abstract is an accurate representation of the teachings of the non-English reference, though, and reserves the right to demonstrate otherwise. Aside from the abstract and the references, the primary known elevance of these references is that they were cited in a co-pending U.S. Patent Application No. 09/595,623, which pertains to related technologies.		
		All cited references References marked by ampersands The following:		
Effect	of Infor	mation Disclosure Statement (37 CFR 1.97(h))		
(i) a se applica third p be, ma of info	earch has ation doe arties ar terial to ormation	on Disclosure Statement is not to be construed as a representation that is been made; (ii) additional information material to the examination of this es not exist; (iii) the information, protocols, results and the like reported by re accurate or enabling; or (iv) the cited information is, or is considered to patentability. In addition, applicant does not admit that any enclosed item is constitutes prior art to the subject invention and specifically reserves the strate that any such reference is not prior art.		
Fee Pa	<u>yment</u>			
No fees are believed due. However, should the Commissioner determine that fees are due in order for this Information Disclosure Statement to be considered, the Commissioner is hereby authorized to charge such fees to Deposit Account No. 50-0665.				
Patent	Term A	djustment (37 CFR 1.704(d))		
	in a conthat the 37 C.F.	dersigned states that each item of information submitted herewith was cited mmunication from a foreign patent office in a counterpart application and is communication was not received by any individual designated in R. § 1.56(c) more than thirty days prior to the filing of this statement. R. § 1.704(d).		

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2/12/2002

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Respectfully submitted,

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